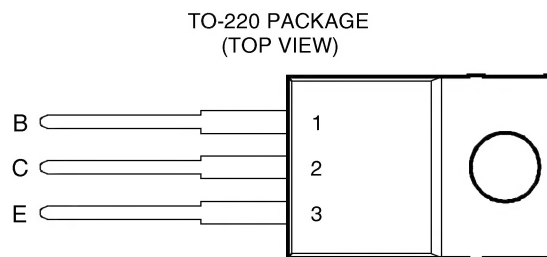




TIP105, TIP106, TIP107 PNP SILICON POWER DARLINGTONS

- Designed for Complementary Use with TIP100, TIP101 and TIP102
- 80 W at 25°C Case Temperature
- 8 A Continuous Collector Current
- Maximum $V_{CE(sat)}$ of 2.5 V at $I_C = 8$ A



Pin 2 is in electrical contact with the mounting base.

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ($I_E = 0$)	TIP105	V_{CBO}	-60	V
	TIP106		-80	
	TIP107		-100	
Collector-emitter voltage ($I_B = 0$)	TIP105	V_{CEO}	-60	V
	TIP106		-80	
	TIP107		-100	
Emitter-base voltage		V_{EBO}	-5	V
Continuous collector current		I_C	-8	A
Peak collector current (see Note 1)		I_{CM}	-15	A
Continuous base current		I_B	-1	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)		P_{tot}	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)		P_{tot}	2	W
Unclamped inductive load energy (see Note 4)		$\frac{1}{2}LI_C^2$	10	mJ
Operating junction temperature range		T_J	-65 to +150	°C
Storage temperature range		T_{stg}	-65 to +150	°C
Lead temperature 3.2 mm from case for 10 seconds		T_L	260	°C

- NOTES: 1. This value applies for $t_p \leq 0.3$ ms, duty cycle $\leq 10\%$.
2. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.
3. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.
4. This rating is based on the capability of the transistor to operate safely in a circuit of: $L = 20$ mH, $I_{B(on)} = -5$ mA, $R_{BE} = 100 \Omega$, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20$ V.

TIP105, TIP106, TIP107

PNP SILICON POWER DARLINGTONS

electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage	$I_C = -30 \text{ mA}$ (see Note 5)	$I_B = 0$	TIP105 TIP106 TIP107	-60 -80 -100			V
I_{CEO}	Collector-emitter cut-off current	$V_{CE} = -30 \text{ V}$ $V_{CE} = -40 \text{ V}$ $V_{CE} = -50 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$	TIP105 TIP106 TIP107			-50 -50 -50	μA
I_{CBO}	Collector cut-off current	$V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$	$I_E = 0$ $I_E = 0$ $I_E = 0$	TIP105 TIP106 TIP107			-50 -50 -50	μA
I_{EBO}	Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$				-8	mA
h_{FE}	Forward current transfer ratio	$V_{CE} = -4 \text{ V}$ $V_{CE} = -4 \text{ V}$	$I_C = -3 \text{ A}$ $I_C = -8 \text{ A}$	(see Notes 5 and 6)	1000 200		20000	
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = -6 \text{ mA}$ $I_B = -80 \text{ mA}$	$I_C = -3 \text{ A}$ $I_C = -8 \text{ A}$	(see Notes 5 and 6)			-2 -2.5	V
V_{BE}	Base-emitter voltage	$V_{CE} = -4 \text{ V}$	$I_C = -8 \text{ A}$	(see Notes 5 and 6)			-2.8	V
V_{EC}	Parallel diode forward voltage	$I_E = -8 \text{ A}$	$I_B = 0$	(see Notes 5 and 6)			-3.5	V

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.
6. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER		MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			1.56	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W
$C_{\theta C}$	Thermal capacitance of case		0.9		J/°C

resistive-load-switching characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_d	Delay time	$I_C = -8 \text{ A}$ $V_{BE(off)} = 5 \text{ V}$	$I_{B(on)} = -80 \text{ mA}$ $R_L = 5 \Omega$	$I_{B(off)} = 80 \text{ mA}$ $t_p = 20 \mu\text{s}$, dc $\leq 2\%$		35		ns
t_r	Rise time					300		ns
t_s	Storage time					900		ns
t_f	Fall time					1.3		μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

TYPICAL CHARACTERISTICS

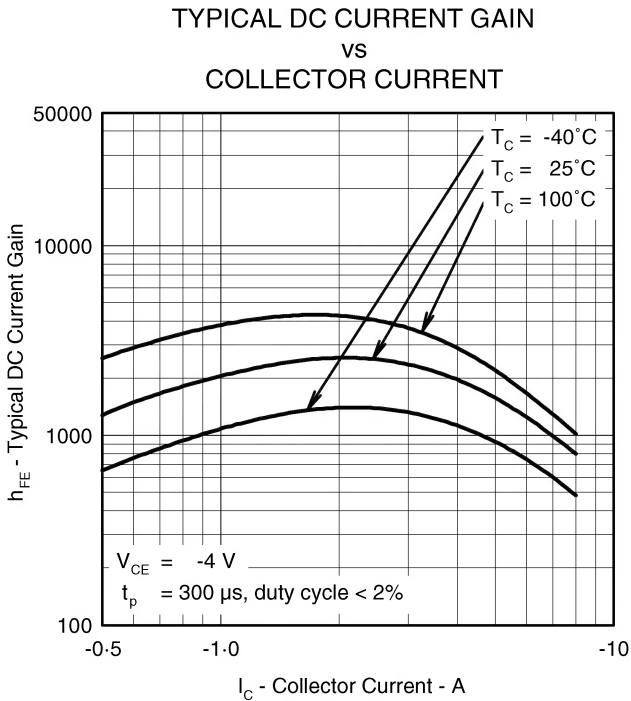


Figure 1.

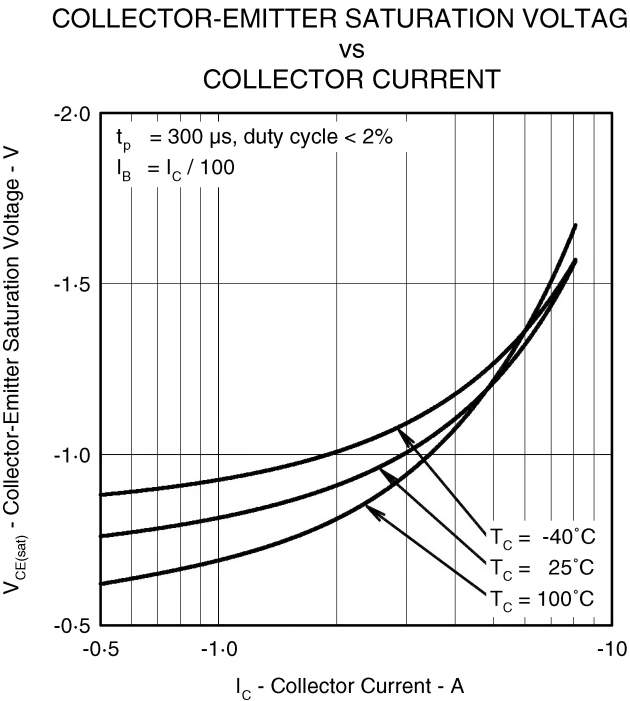


Figure 2.

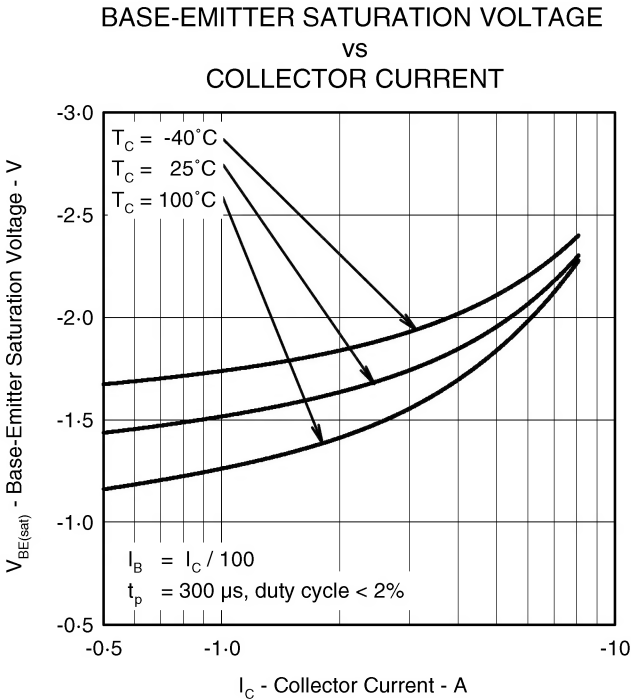


Figure 3.

TIP105, TIP106, TIP107
PNP SILICON POWER DARLINGTONS

MAXIMUM SAFE OPERATING REGIONS

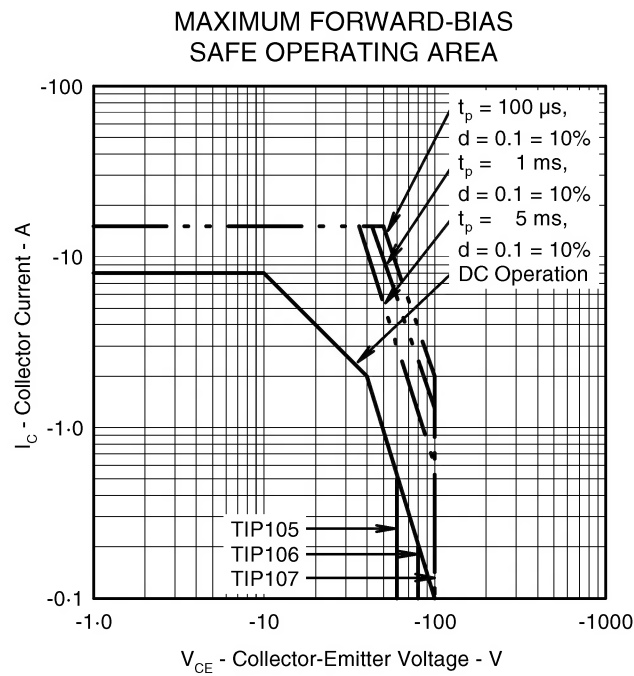


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION
vs
CASE TEMPERATURE

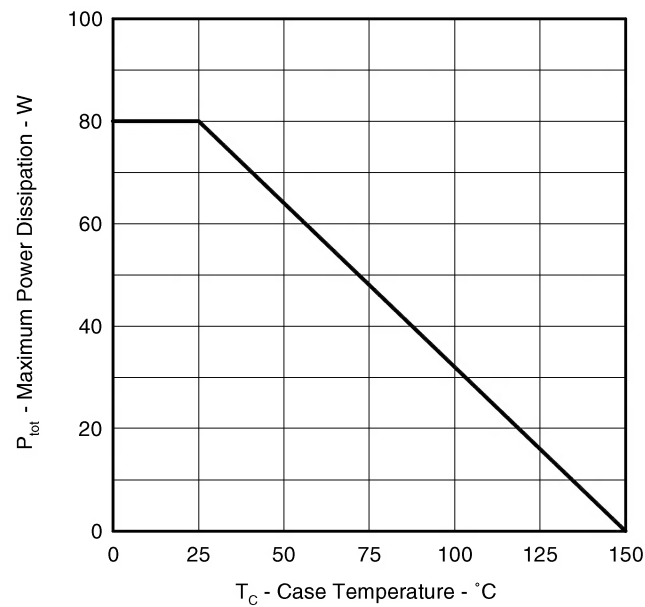


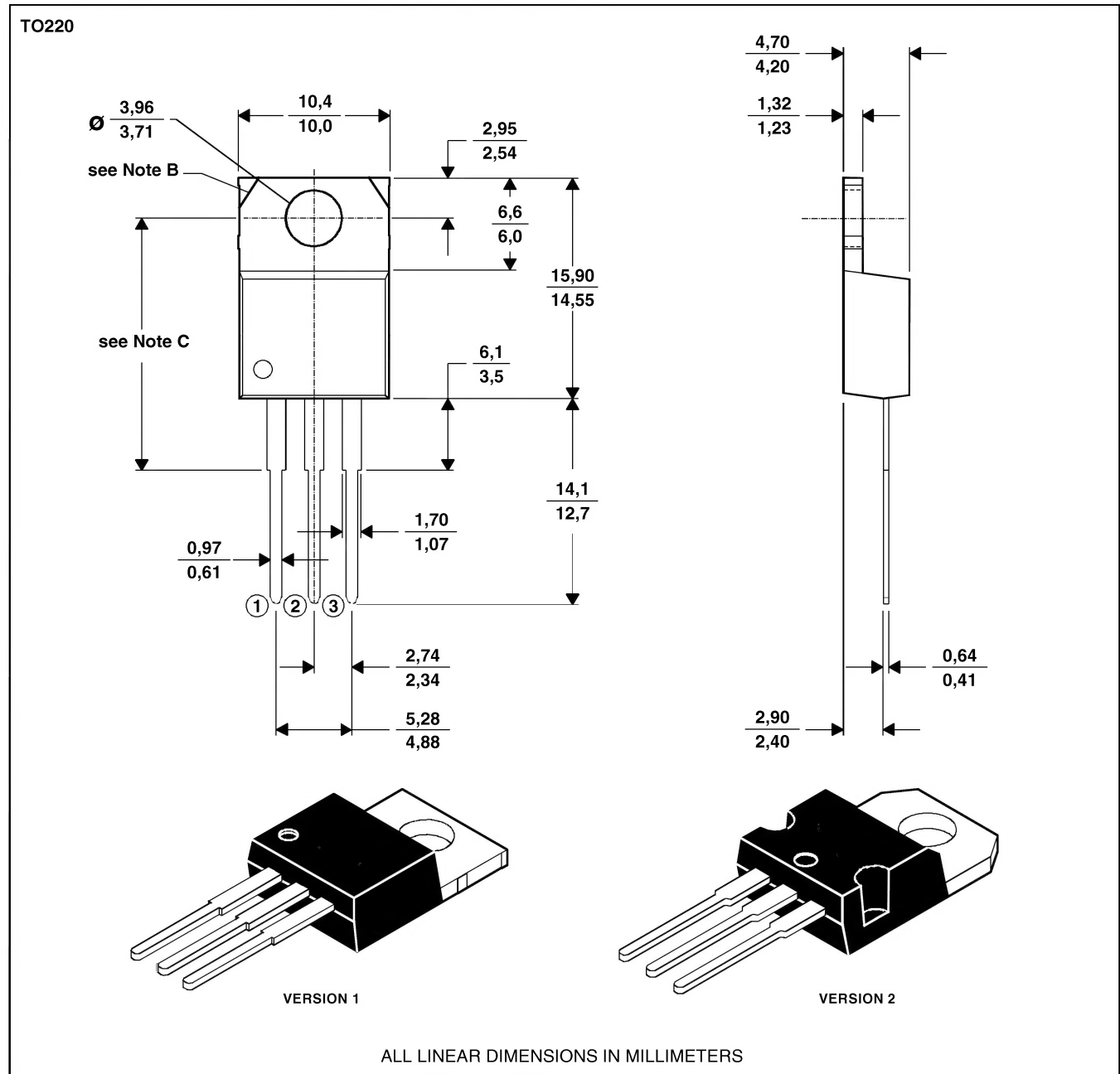
Figure 5.

MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



- NOTES: A. The centre pin is in electrical contact with the mounting tab.
B. Mounting tab corner profile according to package version.
C. Typical fixing hole centre stand off height according to package version.
Version 1, 18.0 mm. Version 2, 17.6 mm.